· 2003年 4月15日(16時52分)。於下電工、YOSHIKAWA INTL PATENT OFFICE 12003年 4月15日至13時34分7PM YOSHIKAWA INTL PATENT OFFICE

P. 5/10_{# 5/10} NO. 761

NO. 7459

DOCKET NO.; 208285US0

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF

NAOTO IKEGAWA, ET AL.

: EXAMINER: UHLIR, N.

SERIAL NO: 09/871,896

JUNE 4, 2001

: GROUP ART UNIT: 1773

LAMINATE FOR:

DECLARATION UNDER 37 C.F.R. & 1.132

ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

SIR:

FILED:

po to Ike saurumo deposes and states:

1. I am a graduate of Kroto Institute of Feband received my Doctor degree in the year 1996

2. I have been employed by Matsushita Electric for 12 years as Works regular employed the sold of molding technolis

3. That the following experiments were carried out and the resulting data are reported balow.

Three base resins were produced as follows:

- e) An erometic polyamide (PPA) base resin was prepared by adding a filler material of boric aluminum at an amount of 70% (by mass) thereto,
- b) A liquid crystal polyester base resin was prepared by adding a filler of fibrous potassium titanste at an amount of 50% (by mass) thereto.
- c) A polyether ether ketone was prepared by adding a filler of glass fiber at an amount of 50% (by mass) thereto.

NO. 745∋ P. 7

A sample of each base rasin produced above was treated by nitrogen plasma, oxygen plasma and argon plasma and a copper metal layer deposited on the base resins using the procedures set forth in the present application at the section titled "Examples" on pages 29-30.

The adhesion between the base resin and the deposited metal was then measured and the results of the experiments are shown in Table 1.

Base resin Filler Nitrogen Oxygen Argon Material Configuration plasma planna planna Atomatic Boric aluminum 70% 1.1N/mm 0,77N/mm I.OAN/mm polyamide (PPA) Liquid Crystal Fibrous potassium 50% 0.55N/mm 0.25N/mm 0,37N/mm polyester Litanate Polyether Ether Glass fiber 50% 0,70N/mm 0.60N/mm 0.55N/mm Ketone

Table 1

- 4. The results of the experiments set forth in Table 1 demonstrate for each different type of base resin containing a different amount of filler material in a different amount within the range of the present claims a higher adhesion for deposited metal to base resin treated by nitrogen plasma over deposited metal to a base resin treated by oxygen plasma or argon plasma from a range of approximately 6% greater adhesion up to 220% greater adhesion. Therefore, it is clear that nitrogen plasma treatment of a base resin containing filler material according to Claim 1 produces superior adhesion between the base resin and deposited metal, as compared to a base resin with filler material treated by oxygen plasma or argon plasma.
- 5. I declare further that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be muc; and further that these

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NO. 761 P. 7/10# 7/10

NO. 7459 P. 8

statements were made with the knowledge that willful false statements and the like so made are purishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of this application or any patent issuing thereon.

6. Further Declarant soith non

Naoto Ikegawa

)ata

3